

3A10 2.46MP product brief





Industry-Leading Low-Light Performance and High Dynamic Range for a Wide Range of Automotive Applications

a lead-free package

OmniVision's OX03A10 is a high-performance, low-power 3.2 µm OmniBSI[™]-2 image sensor designed for a wide range of advanced automotive imaging applications, including 360-degree surround view, rear view, blind-spot detection, e-mirror, and lane departure warning.

The 2.46-megapixel sensor uses OmniVision's proprietary Deep Well[™] pixel technology to deliver industry-leading low-light sensitivity, and enables up to 90 dB of high dynamic range (HDR) from a single exposure without any decrease in signal-to-noise ratio and without motion artifacts. The OXO3A10 also features dual-exposure HDR mode that can extend the sensor's dynamic range to more than 120 dB.

The OXO3A10 can output multiple resolution formats, including 1920 x 1280 resolution video at 50 frames per second (fps) and 1920 x 1080 resolution video at 60 fps.

The sensor comes in an AEC-Q100 Grade 2 qualified chip-scale package or ball grid array package and has been developed according to ISO 26262 ASIL B requirements.

Find out more at www.ovt.com.





Applications

Automotive

- 360° Surround View System - Rear View Camera - Lane Departure Warning / Lane Keep Assist

- Camera Monitoring System/E-Mirror - Autonomous Driving

Technical Specifications

- active array size: 1920 × 1280
- maximum image transfer rate: 1280p: 50 fps
- 1080p: 60 fps 1280p (with FuSa/ASIL on): 40 fps
- 1080p (with FuSa/ASIL on): 45 fps
- power supply: analog: 3.3V
- digital: 1.2V I/O pads: 1.8V
- power requirements:
 active: streaming @ 1280p50:
 370 mW (with FuSa/ASIL off)
- temperature range:
 operating: -40°C to +105°C sensor ambient temperature and -40°C to +125°C junction temperature
- output interfaces: up to 4-lane MIPI CSI-2

- lens size: 1/2.44"
- lens chief ray angle: 19.7°
- scan mode: progressive
- shutter: rolling shutter
- output formats: single exposure HDR · 16-bit combined RAW, 12-bit (PWL) compressed combined RAW; dual exposure HDR - 16-bit combined RAW + 12-bit VS RAW, 12-bit (PWL) compressed combined RAW + 12-bit VSRAW
- pixel size: 3.2 µm x 3.2 µm
- image area: 6195.2 μm x 4147.2 μm
- package cover glass type: double sided anti-reflective (AR/AR) coating (without IRCF)

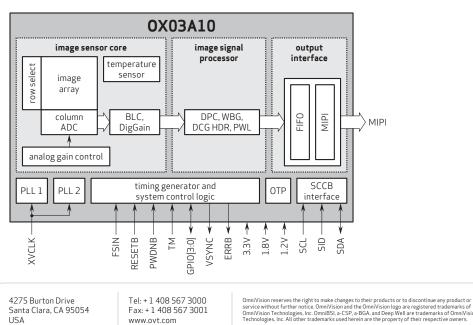
- OX03A10-E80Y-1E (color, lead-free) 80-pin a-CSP[™] packed in tray without protective film
- OX03A10-E80Y-OE (color, lead-free) 80-pin a-CSP[™] packed in tape & reel wth protective film (TL)
- OX03A10-E80Y-LE (color, lead-free) 80-pin a-CSP[™] packed in tray with protective film (TL)
- OX03A10-E80Y-SE (color, lead-free) 80-pin a-CSP[™] packed in tape & reel wth protective film (BL)
- OX03A10-E80Y-QE (color, lead-free) 80-pin a-CSP[™] packed in tray with protective film (BL)
- OX03A10-B83Y-1E (color, lead-free) 83-pin a-BGA[™] packed in tray without protective film
- OX03A10-B83Y-OE (color, lead-free) 83-pin a-BGA[™] packed in tape & reel with protective film
- OX03A10-B83Y-LE (color, lead-free) 83-pin a-BGA[™] packed in tray with protective film

Product Features

- support for image size: - 1920 x 1280 - 1920 x 1080
- VGA - QVGA, and any cropped size
- high dynamic range
- high sensitivity
- image sensor processor functions: defective pixel cancelation
- HDR combination automatic black level correction
 PWL compression, etc.
- pixel data: 12b RAW RGB

- SCCB for register programming
- dedicated safety features for supporting minimum ASILB applications
- programmable GPIOs
- high speed serial data transfer with MIPI CSI-2
- external frame synchronization capability
- embedded temperature sensor
- one time programmable (OTP) memory

Functional Block Diagram



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OX03A10